

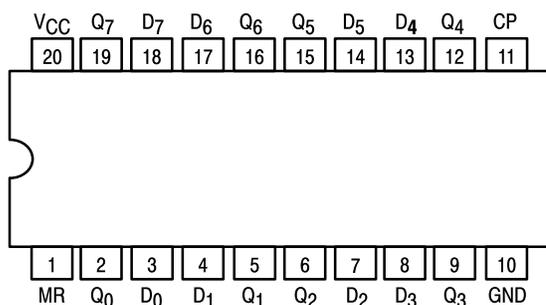


OCTAL D FLIP-FLOP WITH CLEAR

The SN54/74LS273 is a high-speed 8-Bit Register. The register consists of eight D-Type Flip-Flops with a Common Clock and an asynchronous active LOW Master Reset. This device is supplied in a 20-pin package featuring 0.3 inch lead spacing.

- 8-Bit High Speed Register
- Parallel Register
- Common Clock and Master Reset
- Input Clamp Diodes Limit High-Speed Termination Effects

CONNECTION DIAGRAM DIP (TOP VIEW)



PIN NAMES

CP Clock (Active HIGH Going Edge) Input
 D₀-D₇ Data Inputs
 MR Master Reset (Active LOW) Input
 Q₀-Q₇ Register Outputs (Note b)

LOADING (Note a)

	HIGH	LOW
CP	0.5 U.L.	0.25 U.L.
D ₀ -D ₇	0.5 U.L.	0.25 U.L.
MR	0.5 U.L.	0.25 U.L.
Q ₀ -Q ₇	10 U.L.	5 (2.5) U.L.

NOTES:

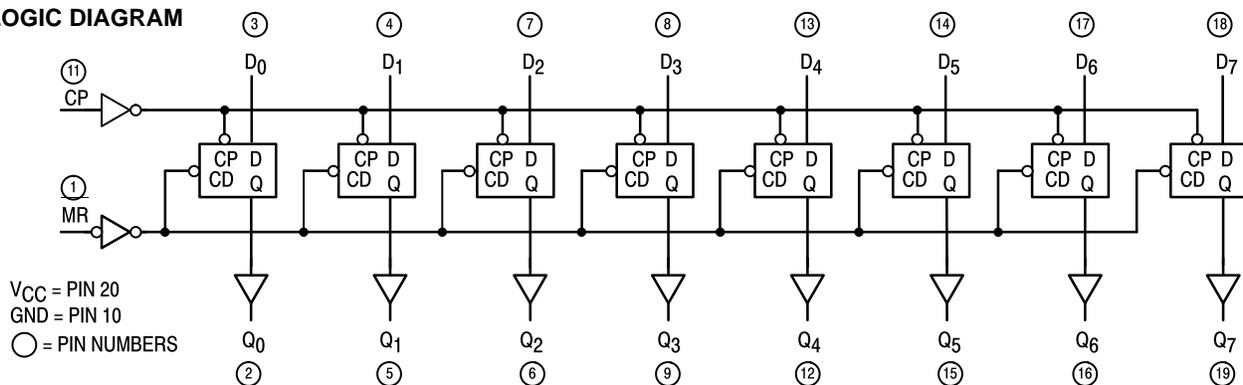
- a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.
 b) The Output LOW drive factor is 2.5 U.L. for Military (54) and 5 U.L. for Commercial (74) Temperature Ranges.

TRUTH TABLE

MR	CP	D _x	Q _x
L	X	X	L
H		H	H
H		L	L

H = HIGH Logic Level
 L = LOW Logic Level
 X = Immaterial

LOGIC DIAGRAM

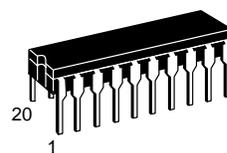


V_{CC} = PIN 20
 GND = PIN 10
 ○ = PIN NUMBERS

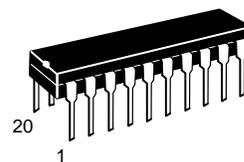
SN54/74LS273

OCTAL D FLIP-FLOP WITH CLEAR

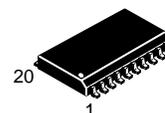
LOW POWER SCHOTTKY



J SUFFIX
 CERAMIC
 CASE 732-03



N SUFFIX
 PLASTIC
 CASE 738-03



DW SUFFIX
 SOIC
 CASE 751D-03

ORDERING INFORMATION

SN54LSXXXJ Ceramic
 SN74LSXXXN Plastic
 SN74LSXXXDW SOIC

SN54/74LS273

FUNCTIONAL DESCRIPTION

The SN54/74LS273 is an 8-Bit Parallel Register with a common Clock and common Master Reset.

When the MR input is LOW, the Q outputs are LOW,

independent of the other inputs. Information meeting the setup and hold time requirements of the D inputs is transferred to the Q outputs on the LOW-to-HIGH transition of the clock input.

GUARANTEED OPERATING RANGES

Symbol	Parameter		Min	Typ	Max	Unit
V _{CC}	Supply Voltage	54	4.5	5.0	5.5	V
		74	4.75	5.0	5.25	
T _A	Operating Ambient Temperature Range	54	-55	25	125	°C
		74	0	25	70	
I _{OH}	Output Current — High	54, 74			-0.4	mA
I _{OL}	Output Current — Low	54			4.0	mA
		74			8.0	

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter		Limits			Unit	Test Conditions
			Min	Typ	Max		
V _{IH}	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs
V _{IL}	Input LOW Voltage	54			0.7	V	Guaranteed Input LOW Voltage for All Inputs
		74			0.8		
V _{IK}	Input Clamp Diode Voltage			-0.65	-1.5	V	V _{CC} = MIN, I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	54	2.5	3.5		V	V _{CC} = MIN, I _{OH} = MAX, V _{IN} = V _{IH} or V _{IL} per Truth Table
		74	2.7	3.5		V	
V _{OL}	Output LOW Voltage	54, 74		0.25	0.4	V	V _{CC} = V _{CC} MIN, V _{IN} = V _{IL} or V _{IH} per Truth Table
		74		0.35	0.5	V	
I _{IH}	Input HIGH Current				20	μA	V _{CC} = MAX, V _{IN} = 2.7 V
					0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V
I _{IL}	Input LOW Current				-0.4	mA	V _{CC} = MAX, V _{IN} = 0.4 V
I _{OS}	Short Circuit Current (Note 1)		-20		-100	mA	V _{CC} = MAX
I _{CC}	Power Supply Current				27	mA	V _{CC} = MAX

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25°C, V_{CC} = 5.0 V)

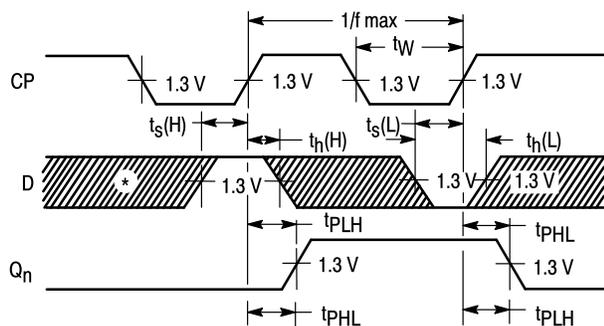
Symbol	Parameter		Limits			Unit	Test Conditions
			Min	Typ	Max		
f _{MAX}	Maximum Input Clock Frequency		30	40		MHz	Figure 1
t _{PHL}	Propagation Delay, MR to Q Output			18	27	ns	Figure 2
t _{PLH}	Propagation Delay, Clock to Output			17	27	ns	Figure 1
				18	27		

SN54/74LS273

AC SETUP REQUIREMENTS ($T_A = 25^\circ\text{C}$, $V_{CC} = 5.0\text{ V}$)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
t_w	Pulse Width, Clock or Clear	20			ns	Figure 1
t_s	Data Setup Time	20			ns	Figure 1
t_h	Hold Time	5.0			ns	Figure 1
t_{rec}	Recovery Time	25			ns	Figure 2

AC WAVEFORMS



*The shaded areas indicate when the input is permitted to change for predictable output performance.

Figure 1. Clock to Output Delays, Clock Pulse Width, Frequency, Setup and Hold Times Data to Clock

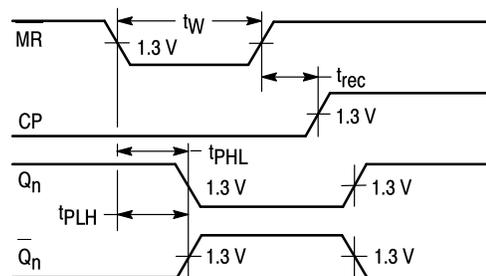


Figure 2. Master Reset to Output Delay, Master Reset Pulse Width, and Master Reset Recovery Time

DEFINITION OF TERMS

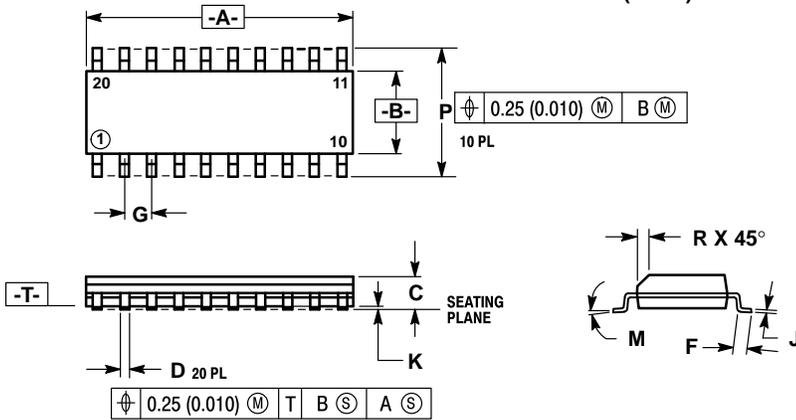
SETUP TIME (t_s) — is defined as the minimum time required for the correct logic level to be present at the logic input prior to the clock transition from LOW-to-HIGH in order to be recognized and transferred to the outputs.

HOLD TIME (t_h) — is defined as the minimum time following the clock transition from LOW-to-HIGH that the logic level must be maintained at the input in order to ensure continued

recognition. A negative HOLD TIME indicates that the correct logic level may be released prior to the clock transition from LOW-to-HIGH and still be recognized.

RECOVERY TIME (t_{rec}) — is defined as the minimum time required between the end of the reset pulse and the clock transition from LOW-to-HIGH in order to recognize and transfer HIGH data to the Q outputs.

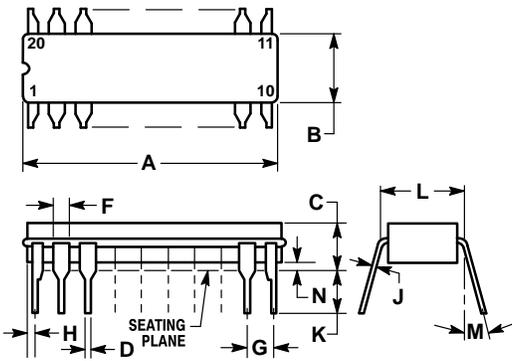
**Case 751D-03 DW Suffix
20-Pin Plastic
SO-20 (WIDE)**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. 751D-01, AND -02 OBSOLETE, NEW STANDARD 751D-03.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.65	12.95	0.499	0.510
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC	0.050 BSC		
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

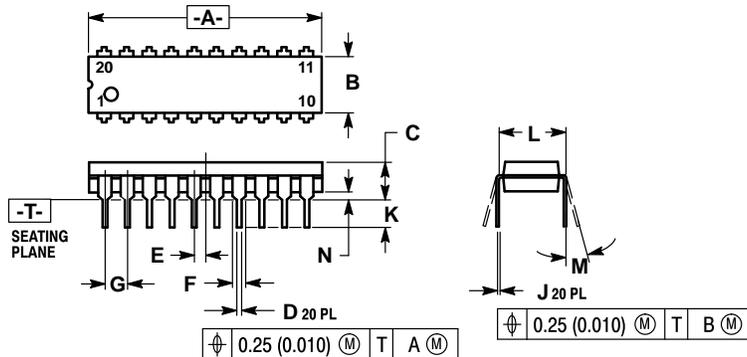
**Case 732-03 J Suffix
20-Pin Ceramic Dual In-Line**



- NOTES:
1. LEADS WITHIN 0.25 mm (0.010) DIA., TRUE POSITION AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
 2. DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 3. DIM A AND B INCLUDES MENISCUS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	23.88	25.15	0.940	0.990
B	6.60	7.49	0.260	0.295
C	3.81	5.08	0.150	0.200
D	0.38	0.56	0.015	0.022
F	1.40	1.65	0.055	0.065
G	2.54 BSC	0.100 BSC		
H	0.51	1.27	0.020	0.050
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	7.62 BSC	0.300 BSC		
M	0°	15°	0°	15°
N	0.25	1.02	0.010	0.040

**Case 738-03 N Suffix
20-Pin Plastic**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION "L" TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
 5. 738-02 OBSOLETE, NEW STANDARD 738-03.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	25.66	27.17	1.010	1.070
B	6.10	6.60	0.240	0.260
C	3.81	4.57	0.150	0.180
D	0.39	0.55	0.015	0.022
E	1.27 BSC	0.050 BSC		
F	1.27	1.77	0.050	0.070
G	2.54 BSC	0.100 BSC		
J	0.21	0.38	0.008	0.015
K	2.80	3.55	0.110	0.140
L	7.62 BSC	0.300 BSC		
M	0°	15°	0°	15°
N	0.51	1.01	0.020	0.040

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